

STGF20NB60S

N-CHANNEL 13A - 600V TO-220FP PowerMESH™ IGBT

Table 1: General Features

TYPE	V _{CES}	V _{CE(sat)} (Max) @25°C	I c @100°C
STGF20NB60S	600 V	< 1.7 V	13 A

- LOW ON-VOLTAGE DROP (V_{cesat})
- **HIGHT CURRENT CAPABILITY**
- OFF LOSSES INCLUDE TAIL CURRENT
- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)

DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The suffix "S" identifies a family optimized to achieve minimum on-voltage drop for low frequency to applications (<1kHz).

APPLICATIONS

- LIGHT DIMMER
- STATIC RELAYS
- MOTOR CONTROL

Figure 1: Package

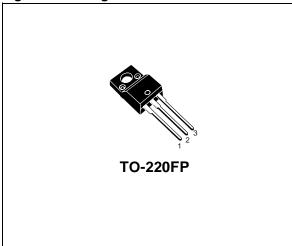


Figure 2: Internal Schematic Diagram

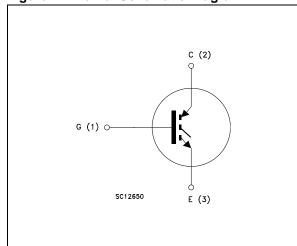


Table 2: Order Code

PART NUMBER	PART NUMBER MARKING PACKAGE		PACKAGING
STGF20NB60S	GF20NB60S	TO-220FP	TUBE

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Table 3: Absolute Maximum ratings

Symbol	Parameter	Value	Unit	
V _{CES}	Collector-Emitter Voltage (V _{GS} = 0)	600	V	
V _{ECR}	Emitter-Collector Voltage	20	V	
V _{GE}	Gate-Emitter Voltage	±20	V	
I _C	Collector Current (continuous) at T _C = 25°C (#)	24	А	
I _C	Collector Current (continuous) at T _C = 100°C (#)	13	А	
I _{CM} (■)	Collector Current (pulsed)	70	Α	
Ртот	Total Dissipation at T _C = 25°C	40	W	
	Derating Factor	0.32	W/°C	
V _{ISO}	Insulation withstand voltage AC (t=1sec, Tc=25°C)	2500	V	
T _{stg}	Storage Temperature	-55 to 150	°C	
Tj	Operating Junction Temperature range	°		

^() Pulse width limited by safe operating area

Table 4: Thermal Data

		Min.	Тур.	Max.	
Rthj-case	Thermal Resistance Junction-case			3.15	°C/W
Rthj-amb	Thermal Resistance Junction-ambient			62.5	°C/W
TL	Maximum Lead Temperature for Soldering Purpose (1.6 mm from case, for 10 sec.)		300		°C

ELECTRICAL CHARACTERISTICS (T_{CASE} =25°C UNLESS OTHERWISE SPECIFIED)

Table 5: On/Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{BR} (CES)	Collector-Emitter Breakdown Voltage	$I_C = 250 \mu A, V_{GE} = 0$	600			V
V _{BR(ECS)}	Emitter-Collector Breakdown Voltage	$I_C = 1 \text{mA}, V_{GE} = 0$	20			V
ICES	Collector cut-off Current (V _{GE} = 0)	V_{CE} = Max Rating, T_{C} = 25 °C V_{CE} = Max Rating, T_{C} = 125 °C			10 100	μA μA
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	V _{GE} = ± 20V , V _{CE} = 0			±100	nA
V _{GE(th)}	Gate Threshold Voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	2.5		5	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	V _{GE} = 15V, I _C = 20 A, Tj= 25°C V _{GE} = 15V, I _C = 20A, Tj=150°C		1.25 1.2	1.7	V V

^(#) Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX} - T_{C}}{R_{THJ-C} \times V_{CESAT(MAX)}(T_{C}, I_{C})}$$

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Table 6: Dynamic

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (1)	Forward Transconductance	V _{CE} = 10 V , I _C = 8 A		20		S
C _{ies}	Input Capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz, } V_{GE} = 0$		1820		pF
C _{oes}	Output Capacitance			167		pF
C _{res}	Reverse Transfer Capacitance			27		pF
Q _g Q _{ge} Q _{gc}	Total Gate Charge Gate-Emitter Charge Gate-Collector Charge	$V_{CC} = 480 \text{ V}, I_{C} = 20 \text{ A},$ $V_{GE} = 15 \text{ V}$ (see Figure 19)		83 10 27	115	nC nC nC
I _{CL}	Turn-off SOA minimum current	$V_{clamp} = 480 \text{ V}$, $Tj = 125^{\circ}C$ $R_G = 100 \Omega$	80			А

⁽¹⁾ Pulsed: Pulse duration= 300 µs, duty cycle 1.5%

Table 7: Switching On

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on Delay Time Current Rise Time Turn-on Current Slope	$V_{CC} = 480 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 100 \Omega, V_{GE} = 15 \text{V}$ (see Figure 17)		92 70 340		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on Delay Time Current Rise Time Turn-on Delay Time	$V_{CC} = 480 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 100 \Omega, V_{GE} = 15 \text{ V},$ $Tj = 125 ^{\circ}\text{C} \text{ (see Figure 17)}$		80 73 320		ns ns A/µs

Table 8: Switching Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _c	Cross-over Time	$V_{CC} = 480 \text{ V}, I_{C} = 20 \text{ A},$		1.6		μs
$t_{\text{r}}(V_{\text{off}})$	Off Voltage Rise Time	$R_G = 100 \Omega$, $V_{GE} = 15 V$ $T_{J} = 25 °C$		0.78		μs
$t_{d(off)}$	Turn-off Delay Time	(see Figure 17)		1.1		μs
t_f	Current Fall Time			0.79		μs
t _c	Cross-over Time	$V_{CC} = 480 \text{ V}, I_{C} = 20 \text{ A},$		2.4		μs
$t_{r}(V_{Off})$	Off Voltage Rise Time	$R_G = 100 \Omega$, $V_{GE} = 15 V$ $T_i = 125 °C$		1.1		μs
$t_{d(off)}$	Turn-off Delay Time	(see Figure 17)		2.4		μs
t_f	Current Fall Time			1.2		μs

Table 9: Switching Energy

Symbol	Parameterr	Test Conditions	Min.	Тур.	Max	Unit
Eon (2) E _{off} (3) E _{ts}	Turn-on Switching Losses Turn-off Switching Loss Total Switching Loss	$V_{CC} = 480 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 100 \Omega, V_{GE} = 15 \text{ V},$ (see Figure 18)		0.84 7.4 8.24		mJ mJ mJ
Eon (2) E _{off} (3) E _{ts}	Turn-on Switching Losses Turn-off Switching Loss Total Switching Loss	$V_{CC} = 480 \text{ V, } I_{C} = 20 \text{ A}$ $R_{G} = 100 \Omega$, $V_{GE} = 15 \text{ V,Tj} = 125 ^{\circ}\text{C}$ (see Figure 18)		0.86 11.5 12.4		mJ mJ mJ

⁽²⁾ Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode.



⁽³⁾ Turn-off losses include also the tail of the collector current.

Figure 3: Output Characteristics

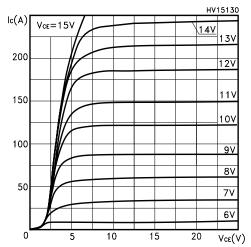


Figure 4: Transconductance

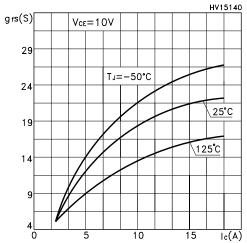


Figure 5: Collector-Emitter On Voltage vs Collector Current

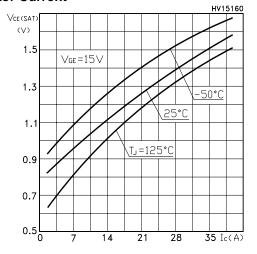


Figure 6: Transfer Characteristics

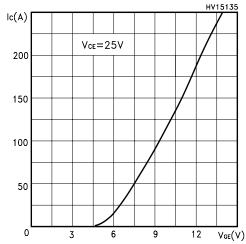


Figure 7: Normalized Collector-Emitter On Voltage vs Temperature

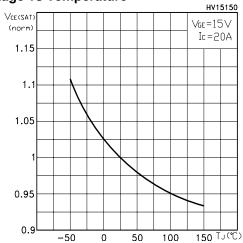
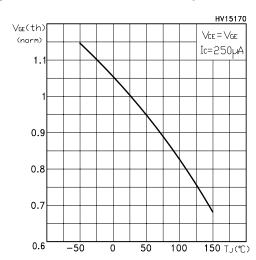


Figure 8: Gate Threshold vs Temperature



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Figure 9: Normalized Breakdown Voltage vs Temperature

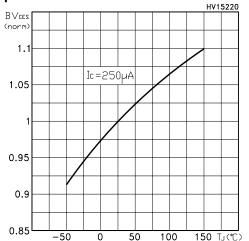


Figure 10: Capacitance Variations

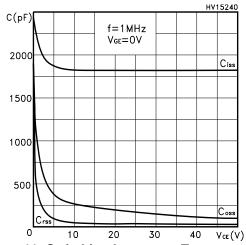


Figure 11: Switching Losses vs Temperature

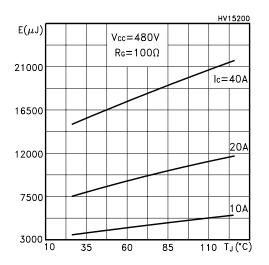


Figure 12: Gate Charge vs Gate-Emitter Voltage

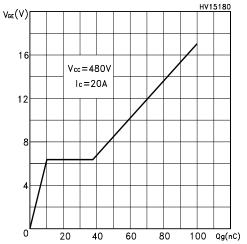


Figure 13: Switching Losses vs Gate Charge

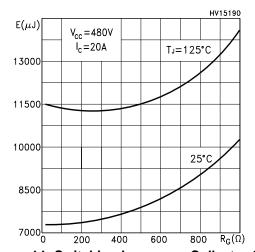


Figure 14: Switching Losses vs Collector Current

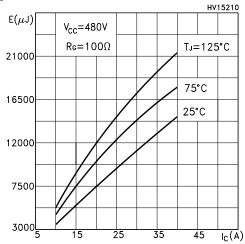


Figure 15: Thermal Impedance

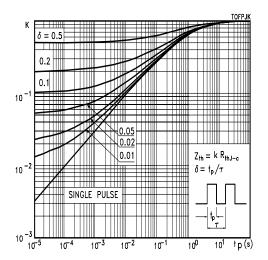
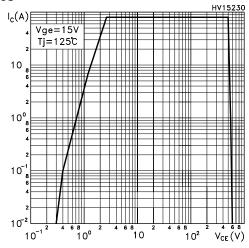


Figure 16: Collector-Emitter Diode Characteristics



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Figure 17: Test Circuit for Inductive Load Switching

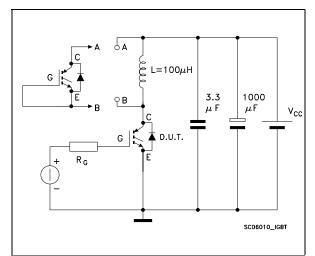


Figure 18: Switching Waveforms

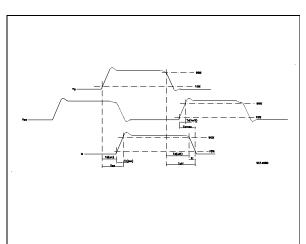
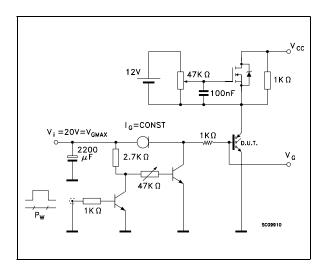
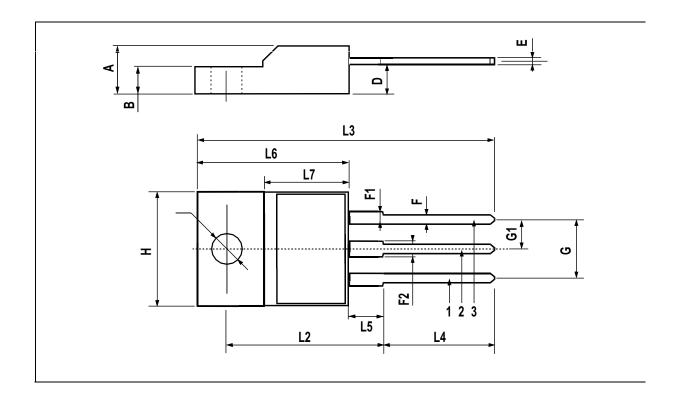


Figure 19: Gate Charge Test Circuit



TO-220FP MECHANICAL DATA

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
Е	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
Н	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	.0385		0.417
L5	2.9		3.6	0.114		0.141
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



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Table 10: Revision History

Date	Revision	Description of Changes
17-Dec-2004	2	New template, no content change

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